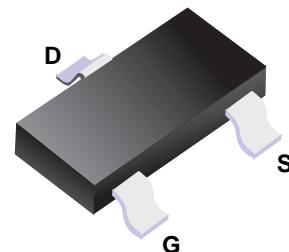


# RC100N05

## ■ Description

The RC100N05 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

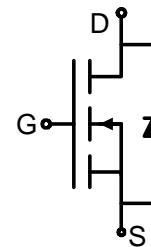


■ Simplified outline(SOT23-3L)

## ■ General Features

V <sub>DSS</sub>	R <sub>DS(ON)</sub> @10V (typ)	I <sub>D</sub>
100V	135mΩ	5A

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation



■ Schematic diagram

## ■ Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

## Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	5	A
Drain Current-Pulsed <sup>(Note 1)</sup>	I <sub>DM</sub>	20	A
Maximum Power Dissipation	P <sub>D</sub>	3	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 To 150	°C

## Thermal Characteristic

Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup>	R <sub>θJA</sub>	41.7	°C/W
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## Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	105	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V	-	-	800	nA

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Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±30	uA
<b>On Characteristics</b> <small>(Note 3)</small>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	2	3	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =5A -		135	150	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =2.9A	-	8	-	S
<b>Dynamic Characteristics</b> <small>(Note 4)</small>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, F=1.0MHz	-	690	-	PF
Output Capacitance	C <sub>oss</sub>		-	120	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	90	-	PF
<b>Switching Characteristics</b> <small>(Note 4)</small>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =30V, I <sub>D</sub> =2A, R <sub>L</sub> =15Ω V <sub>GS</sub> =10V, R <sub>G</sub> =2.5Ω	-	11	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	7.4	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	35	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	9.1	-	nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =30V, I <sub>D</sub> =3A, V <sub>GS</sub> =10V	-	15.5	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	3.2	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	4.7	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <small>(Note 3)</small>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =6A	-	-	1.2	V
Diode Forward Current <small>(Note 2)</small>	I <sub>S</sub>		-	-	6	A

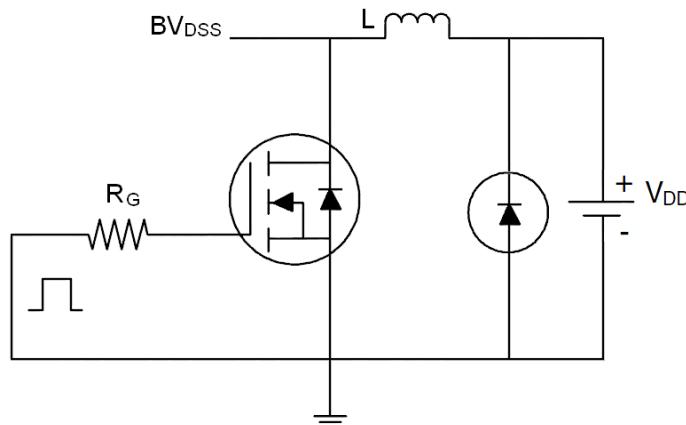
## Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

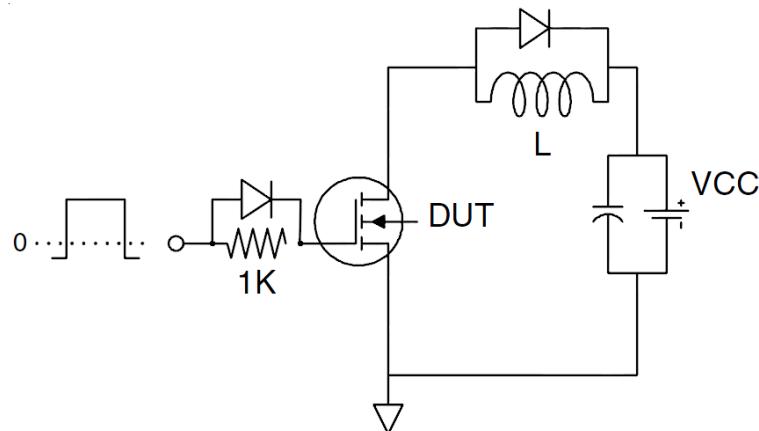
# RC100N05

## Test Circuit

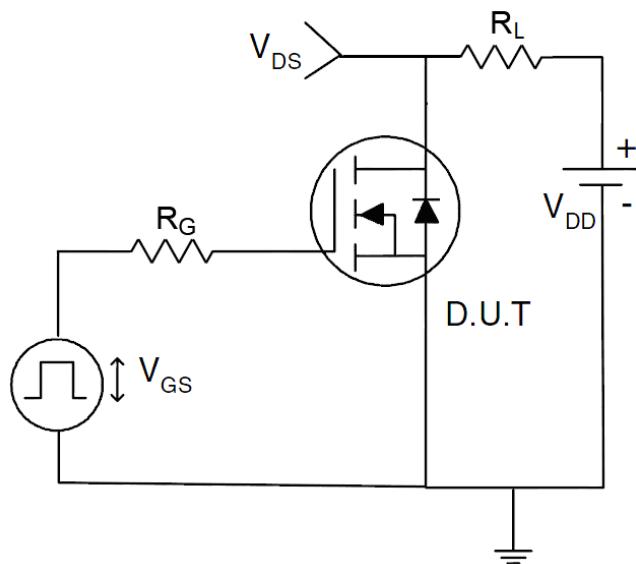
### 1) E<sub>AS</sub> test circuit



### 2) Gate charge test circuit



### 3) Switch Time Test Circuit



# RC100N05

## Typical Electrical and Thermal Characteristics (curves)

Figure1. Source-Drain Diode Forward Voltage

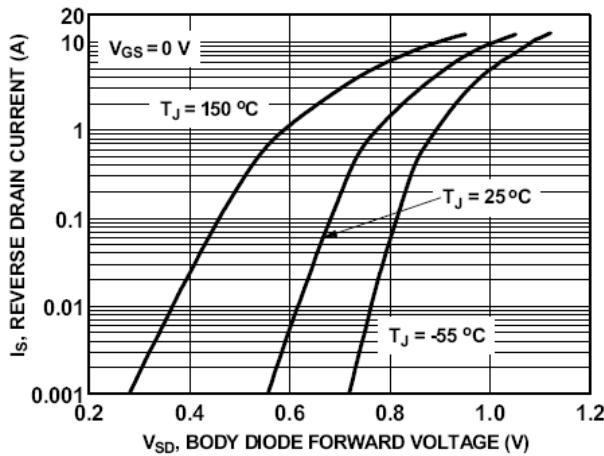


Figure2. Safe operating area

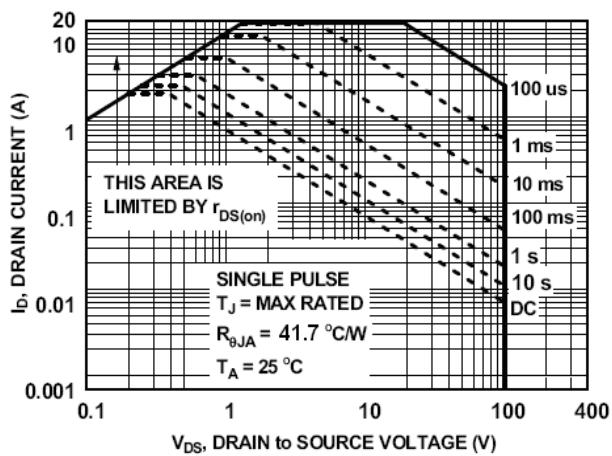


Figure3. Output characteristics

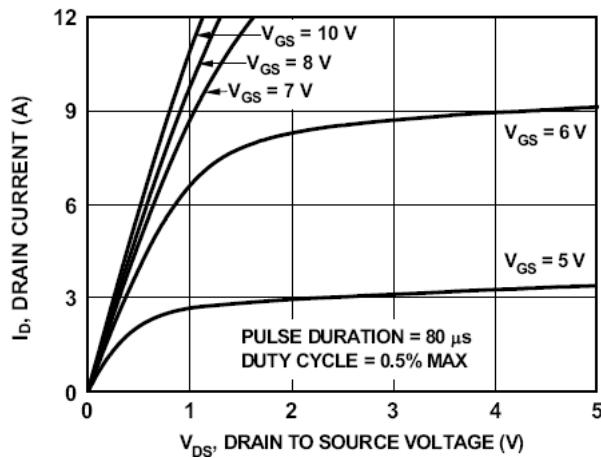


Figure4. Transfer characteristics

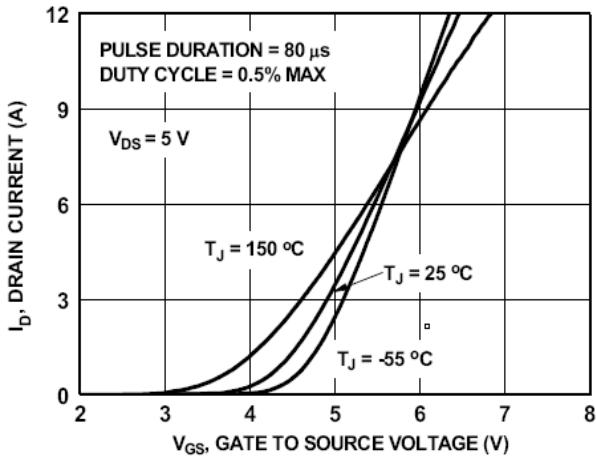


Figure5. Static drain-source on resistance

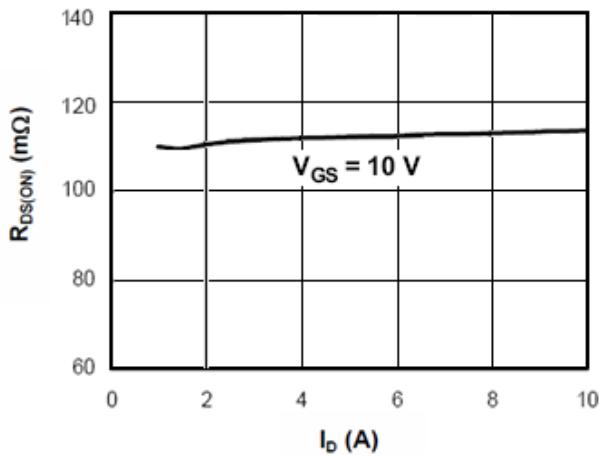
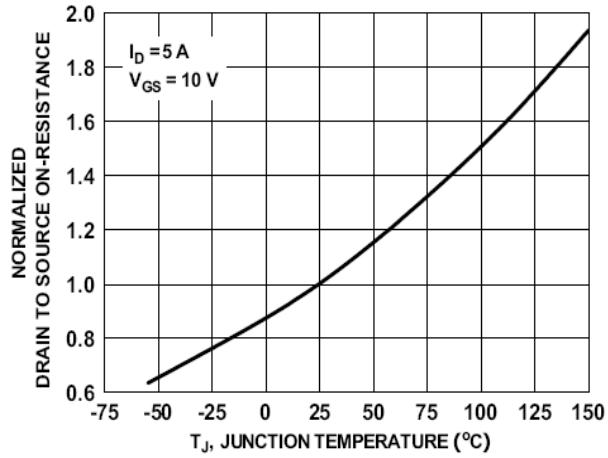
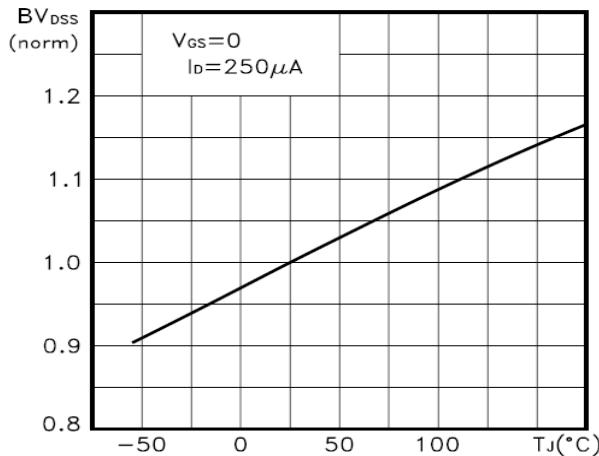


Figure6.  $R_{DS(on)}$  vs Junction Temperature

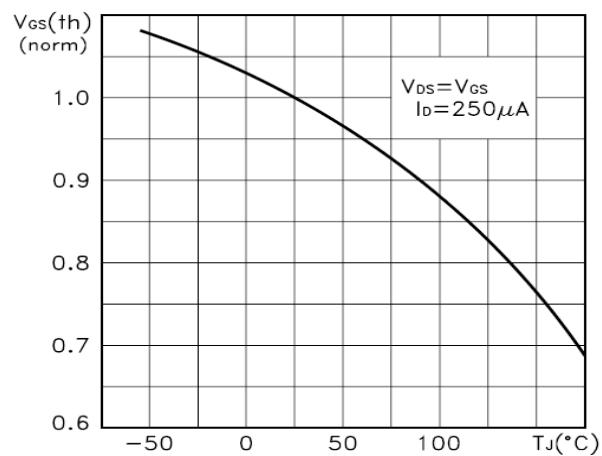


# RC100N05

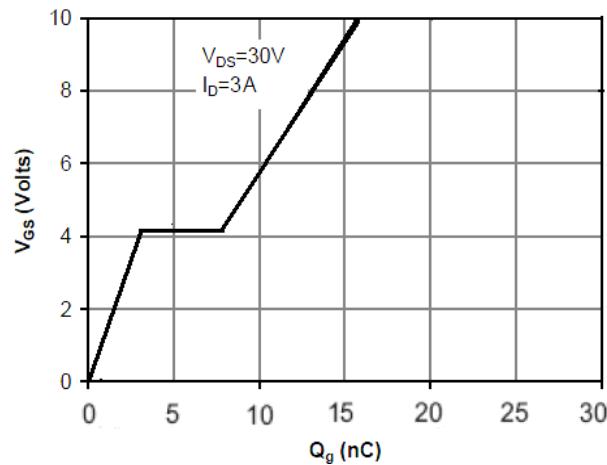
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



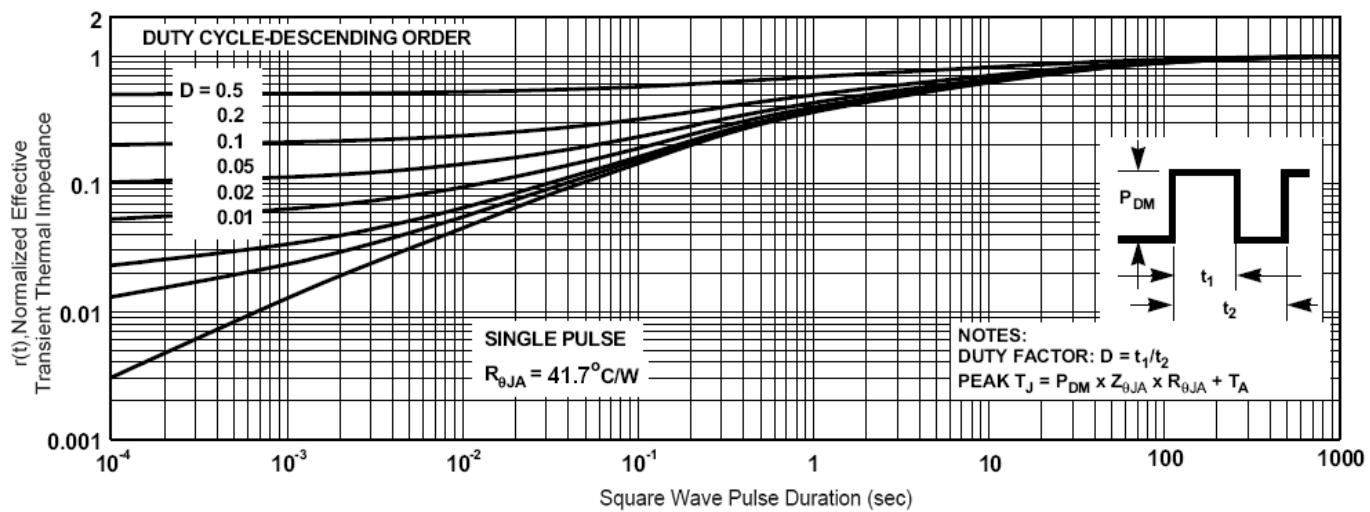
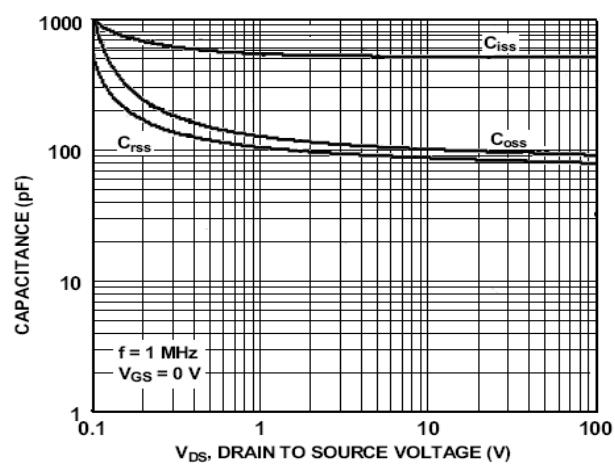
**Figure8.  $V_{GS(th)}$  vs Junction Temperature**



**Figure9. Gate charge waveforms**



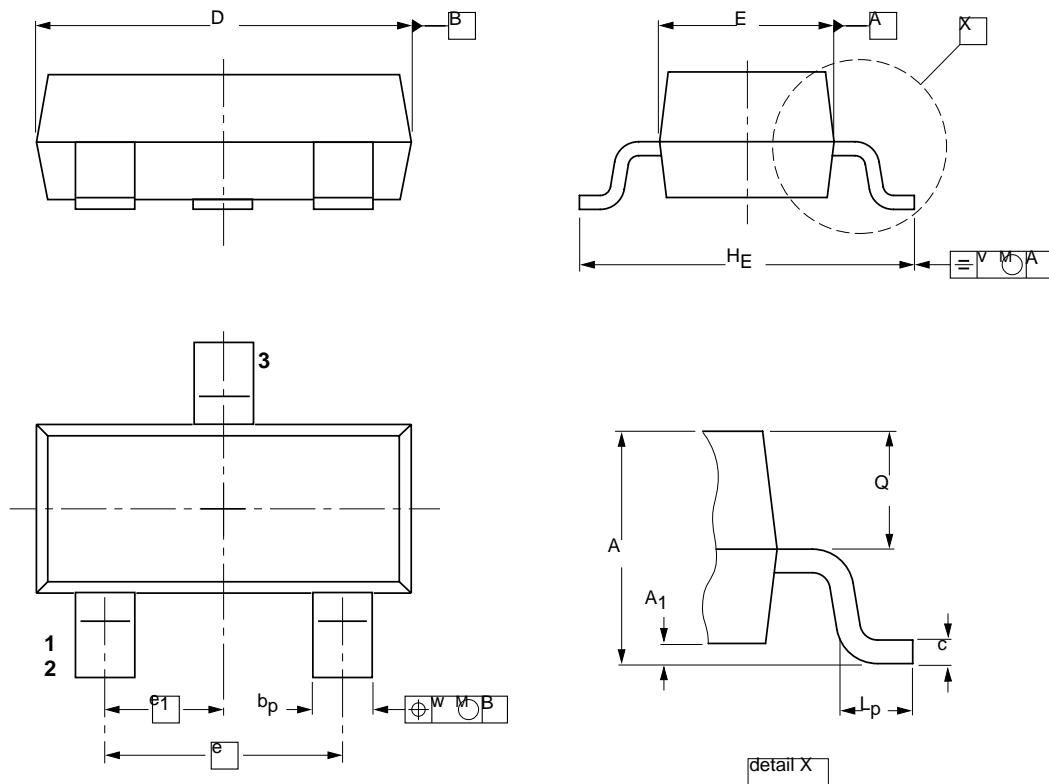
**Figure10. Capacitance**



**Figure11. Normalized Maximum Transient Thermal Impedance**

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## Package Outline



0      1      2 mm  
scale

### DIMENSIONS (mm are the original dimensions)

UNIT	A	$A_1$ max.	$b_p$	c	D	E	e	$e_1$	$H_E$	$L_p$	$Q_w$	v	
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

## Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
SOT-23-3L	Tape/Reel, 7" reel	3000	EIA-48-1